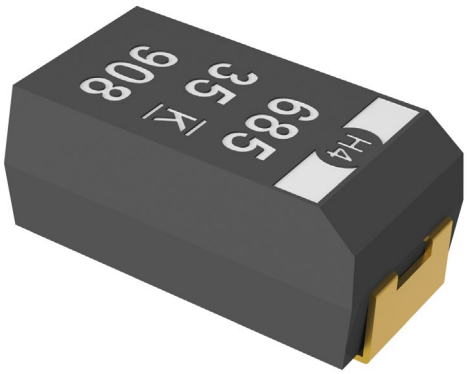
## Overview

The KEMET T502 is a high temperature product that offers optimum performance characteristics in applications with operating temperatures up to 230°C. The T502 is classified as moisture sensitivity level (MSL) 1 under J STD 020: unlimited floor life time at ≤ 30°C/85% RH.

Due to the potential use of high melting point solders, KEMET has taken the initiative to package this product in moisture barrier bags with desiccant and a humidity indicator card.

## Benefits

- F-Tech and 100% SBDS (KEMET's patented Simulated Breakdown Voltage Screening)
- 3 Sigma Screening for iL, DF, and ESR
- Qualified at 1,000 hours of life test at 230°C at 0.33 Vr
- Voltage derating of  33% at 230°C
- Unique high temperature material set
- Meets or exceeds EIA standard 535BAAC
- Standard gold-plated terminations
- RoHS compliant
- Operating temperature range of −55ºC to +230ºC
- Voltage derating applies
- Tape & Reel standard packaging per EIA 481
- Meets MSL 1 requirements for Pb-free assembly according to JEDEC J–STD–020
- Packaged in moisture barrier bags with desiccant and a humidity indicator card
- Surge current options available




## Applications

Typical applications include decoupling and filtering for very high temperature environments such as measurement-while-drilling (MWD) in down-hole applications.

## K-SIM

For a detailed analysis of specific part numbers, please visit ksim3.kemet.com to access KEMET's K-SIM software. KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels.

## Ordering Information

| T | 502 | D | 685 | M | 035 | A | G | 61 | 10 | |
|---|---|---|---|---|---|---|---|---|---|---|
| Capacitor Class | Series | Case Size | Capacitance Code (pF) | Capacitance Tolerance | Rated Voltage (VDC) | Failure Rate/ Design | Termination Finish | Added Surge Current Options | ESR | Packaging (C-Spec) |
| T = Tantalum | High temperature 230°C | B<br>C<br>D | First two digits represent significant figures. Third digit specifies number of zeros. | K = ±10%<br>M = ±20% | 016 = 16<br>020 = 20<br>025 = 25<br>035 = 35 | A = N/A | G = Gold-plated | 61 = No additional surge current testing<br>62 = 10 Cycles, 25°C ±5°C, after Weibull<br>63 = 10 Cycles, -55°C ±5°C and +85°C ±5°C, after Weibull | 10 = Standard ESR | Blank = 7" reel<br>7280 = 13" reel |

## Performance Characteristics

| Item | Performance Characteristics |
|---|---|
| Operating Temperature | −55°C to 230°C |
| Rated Capacitance Range | 4.7 – 33 µF at 120 Hz/25°C |
| Capacitance Tolerance | K Tolerance (10%), M Tolerance (20%) |
| Rated Voltage Range | 16 – 35 V |
| DF (120 Hz) | Refer to Part Number Electrical Specification Table |
| ESR (100 kHz) | Refer to Part Number Electrical Specification Table |
| Leakage Current | ≤ 0.01 CV (µA) at rated voltage after 5 minutes |

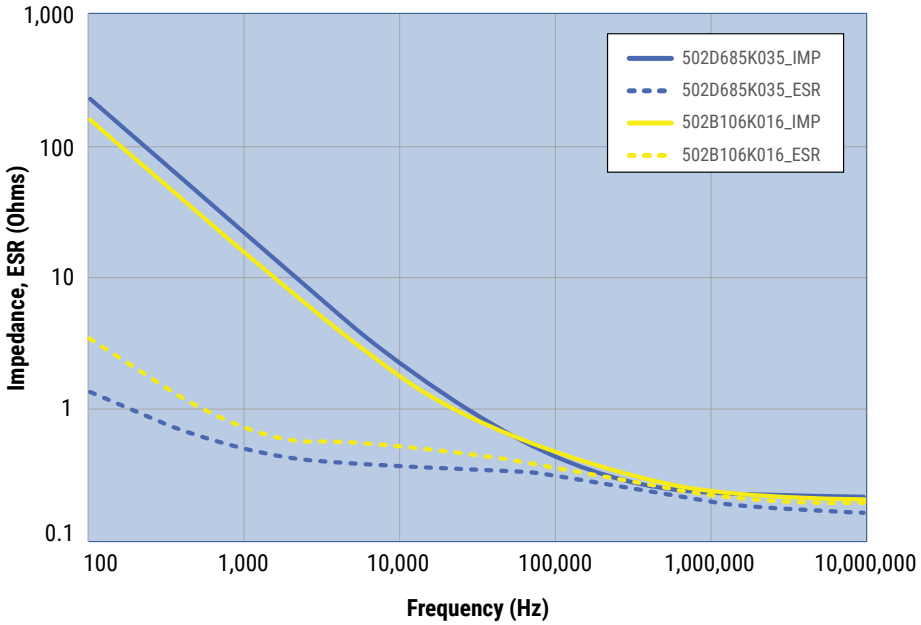
## Qualification

| Test | Condition | | Characteristics | | | |
|---|---|---|---|---|---|---|
| Endurance | 230°C at 1/3 rated voltage, 500 hours | | Δ C/C | Within ±10% of initial value | | |
| | | | DF | Within 1.5 x initial limits | | |
| | | | DCL | 1 mAmp maximum | | |
| | | | ESR | Within 2.0 x initial limits | | |
| Storage Life | 230°C at 0 volts, 1,000 hours | | Δ C/C | Within ±10% of initial value | | |
| | | | DF | Within 1.5 x initial limits | | |
| | | | DCL | 1 mAmp maximum | | |
| | | | ESR | Within 2.0 x initial limits | | |
| Humidity | 85°C, 85% RH, 0 V, 500 hours | | Δ C/C | Within ±10% of initial value | | |
| | | | DF | Within initial limits | | |
| | | | DCL | Within initial limits | | |
| | | | ESR | Within initial limits | | |
| Temperature Stability | Extreme temperature exposure at a succession of continuous steps at +25°C, −55°C, +25°C, +85°C, +150°C, +25°C | | +25°C | −55°C | +85°C | +150°C |
| | | Δ C/C | IL* | ±10% | ±10% | ±20% |
| | | DF | IL | IL | 1.5 x IL | 1.5 x IL |
| | | DCL | IL | N/A | 10 x IL | 12 x IL |
| Mechanical Shock/ Vibration | MIL–STD–202, Method 213, Condition I, 100 G peak<br>MIL–STD–202, Method 204, 10 Hz to 2,000 Hz, 5G for 20 minutes, 12 cycles each of 3 orientations | | Δ C/C | Within ±10 of initial value | | |
| | | | DF | Within initial limits | | |
| | | | DCL | Within initial limits | | |

**IL = Initial limit*

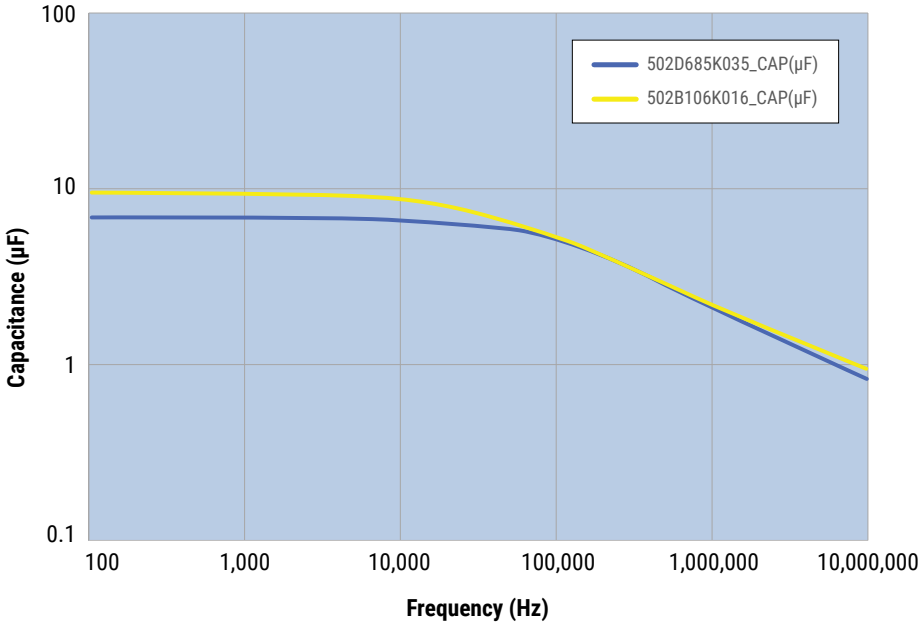
## Electrical Characteristics

### Impedance & ESR vs. Frequency



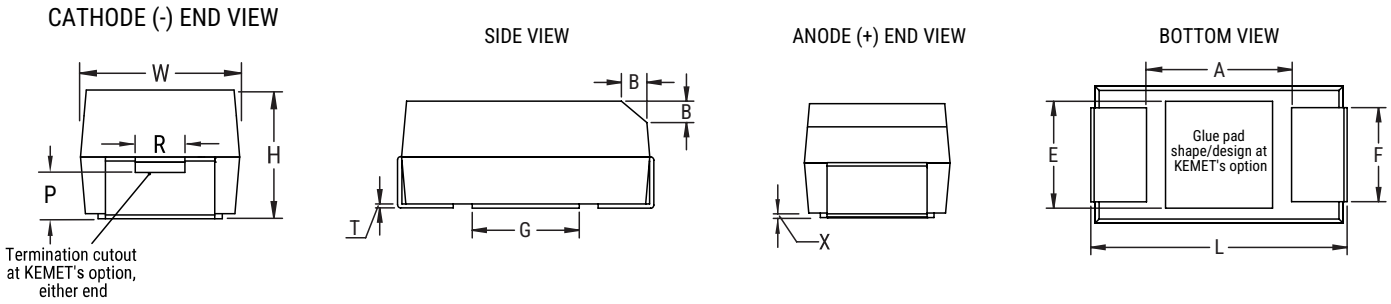

*The measurements were taken at room temperature (25°C)*

### Capacitance vs. Frequency




*The measurements were taken at room temperature (25°C)*

## Dimensions – Millimeters




| Case Size | | Component Dimensions | | | | | | |
|---|---|---|---|---|---|---|---|---|
| KEMET | EIA | L | W | H | F | S | B (Ref) | X (Ref) |
| B | 3528-21 | 3.5 ±0.2 (0.138 ±0.008) | 2.8 ±0.2 (0.110 ±0.008) | 1.9 ±0.2 (0.075 ±0.008) | 2.2 ±0.1 (0.087 ±0.004) | 0.80 +0.1/-0.3 (0.032 +0.004/-0.012) | 0.4 ±0.15 (0.016 ±0.006) | 0.10 ±0.10 (0.004 ±0.004) |
| C | 6032-28 | 6.0 ±0.3 (0.236 ±0.012) | 3.2 ±0.3 (0.126 ±0.012) | 2.5 ±0.3 (0.098 ±0.012) | 2.2 ±0.1 (0.087±0.004) | 1.3 (0.051) ±0.3 (0.012) | 0.5 ±0.15 (0.020 ±0.006) | 0.10 ±0.10 (0.004 ±0.004) |
| D | 7343-31 | 7.3 ±0.3 (0.287 ±0.012) | 4.3 ± 0.3 (0.169 ±0.012) | 2.8 ± 0.3 (0.110 ±0.012) | 2.4 ±0.1 (0.094 ±0.004) | 1.3 ±0.3 (0.051 ±0.012)" | 0.5 ±0.15 (0.020 ±0.006) | 0.10 ± 0.10 (0.004 ±0.004) |

| Case Size | | Component Dimensions | | | | | | |
|---|---|---|---|---|---|---|---|---|
| KEMET | EIA | P (Ref) | R (Ref) | T (Ref) | A (Minimum) | G (Ref) | E (Ref) | Typical Weight (mg) |
| B | 3528-21 | 0.5 (0.020) | 1.0 (0.039) | 0.13 (0.005) | 1.9 (0.075) | 1.8 (0.071) | 2.2 (0.087) | 53.17 |
| C | 6032-28 | 0.9 (0.035) | 1.0 (0.039) | 0.13 (0.005) | 2.9 (0.114) | 2.8 (0.110) | 2.4 (0.094) | 98.30 |
| D | 7343-31 | 0.9 (0.035) | 1.0 (0.039) | 0.13 (0.005) | 3.8 (0.150) | 3.5 (0.138) | 3.5 (0.138) | 193.46 |

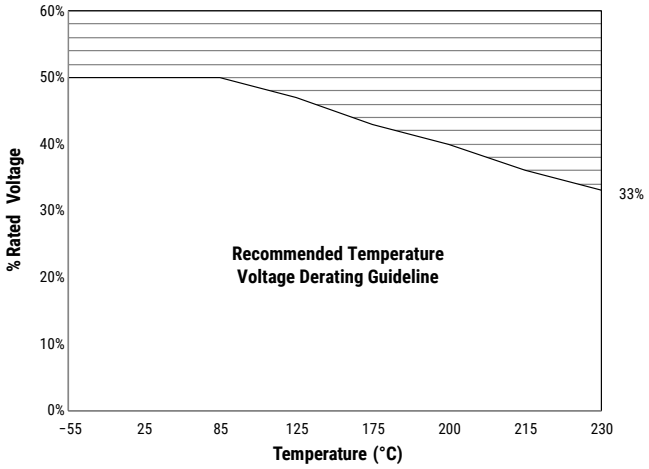
*Notes: (Ref) – Dimensions provided for reference only.*
*These weights are provided as reference. If exact weights are needed, please contact your KEMET Sales Representative*

## Table 1 – Ratings & Part Number Reference

| Rated Voltage | Rated Cap | Case Code/ Case Size | KEMET Part Number | DC Leakage | DF | ESR | Maximum Allowable Ripple Current (rms) | Maximum Operating Temp. |
|---|---|---|---|---|---|---|---|---|
| VDC at 85°C | µF | KEMET/EIA | (See below for part options) | µA at 25°C Max/ 5 Minutes | % at 25°C 120 Hz Max | Ω at 25°C 100 kHz Max | mA at +45°C 100 kHz | °C |
| 16 | 10 | B/3528-21 | T502B106(1)016AG(2)10 | 1.6 | 6 | 2.8 | 174 | 230 |
| 16 | 33 | D/7343-31 | T502D336(1)016AG(2)10 | 5.3 | 6 | 0.7 | 460 | 230 |
| 20 | 4.7 | C/6032-28 | T502C475(1)020AG(2)10 | 0.9 | 6 | 2.0 | 235 | 230 |
| 20 | 10 | C/6032-28 | T502C106(1)020AG(2)10 | 2.0 | 6 | 1.5 | 271 | 230 |
| 20 | 22 | D/7343-31 | T502D226(1)020AG(2)10 | 4.4 | 6 | 0.7 | 460 | 230 |
| 20 | 33 | D/7343-31 | T502D336(1)020AG(2)10 | 6.6 | 6 | 0.7 | 460 | 230 |
| 25 | 4.7 | C/6032-28 | T502C475(1)025AG(2)10 | 1.2 | 6 | 2.0 | 235 | 230 |
| 25 | 6.8 | C/6032-28 | T502C685(1)025AG(2)10 | 1.7 | 6 | 1.9 | 271 | 230 |
| 25 | 10 | C/6032-28 | T502C106(1)025AG(2)10 | 2.5 | 6 | 1.5 | 271 | 230 |
| 25 | 10 | D/7343-31 | T502D106(1)025AG(2)10 | 2.5 | 6 | 1.8 | 289 | 230 |
| 25 | 15 | D/7343-31 | T502D156(1)025AG(2)10 | 3.8 | 6 | 0.7 | 460 | 230 |
| 25 | 22 | D/7343-31 | T502D226(1)025AG(2)10 | 5.5 | 6 | 0.7 | 460 | 230 |
| 25 | 33 | D/7343-31 | T502D336(1)025AG(2)10 | 8.3 | 6 | 0.7 | 460 | 230 |
| 35 | 4.7 | C/6032-28 | T502C475(1)035AG(2)10 | 1.7 | 6 | 2.0 | 235 | 230 |
| 35 | 6.8 | D/7343-31 | T502D685(1)035AG(2)10 | 2.4 | 6 | 1.8 | 289 | 230 |
| 35 | 10 | D/7343-31 | T502D106(1)035AG(2)10 | 3.5 | 6 | 1.0 | 390 | 230 |
| 35 | 15 | D/7343-31 | T502D156(1)035AG(2)10 | 5.3 | 6 | 0.7 | 460 | 230 |
| 35 | 22 | D/7343-31 | T502D226(1)035AG(2)10 | 7.7 | 6 | 0.7 | 460 | 230 |

*(1) To complete KEMET part number, insert M for ±20% or K for ±10%. Designates capacitance tolerance.*
*(2) To complete KEMET part number, insert 61, 62, 63. Designates surge current option.*

## Recommended Voltage Derating Guidelines




| Rated Voltage | Working Voltage | | | | | |
|---|---|---|---|---|---|---|
| | 25°C | 85°C | 125°C | 200°C | 215°C | 230°C |
| 16 | 16 | 16 | 13.1 | 7.5 | 6.4 | 5.3 |
| 20 | 20 | 20 | 16.4 | 9.4 | 8.0 | 6.6 |
| 25 | 25 | 25 | 20.5 | 11.8 | 10 | 8.3 |
| 35 | 35 | 35 | 28.7 | 16.5 | 14 | 11.6 |

*Note: Additional reliability can be obtained through the derating of voltage*

## Ripple Current/Ripple Voltage

Permissible AC ripple voltage and current are related to equivalent series resistance (ESR) and the power dissipation capabilities of the device. Permissible AC ripple voltage which may be applied is limited by two criteria:

1. The positive peak AC voltage plus the DC bias voltage, if any, must not exceed the DC voltage rating of the capacitor.
2. The negative peak AC voltage in combination with bias voltage, if any, must not exceed the allowable limits specified for reverse voltage. See the Reverse Voltage section for allowable limits.

The maximum power dissipation by case size can be determined using the table at right. The maximum power dissipation rating stated in the table must be reduced with increasing environmental operating temperatures. Refer to the table below for temperature compensation requirements.

| Temperature Compensation Multipliers for Maximum Ripple Current | | |
|---|---|---|
| T ≤ 200°C | 200 ≥ 220°C | 220 ≥ 230°C |
| 1.00 | 0.70 | 0.30 |

*T = Environmental temperature*

| KEMET Case Code | EIA Case Code | Maximum Power Dissipation (Pmax) mWatts at 25°C with +20°C Rise |
|---|---|---|
| B | 3528–21 | 85 |
| C | 6032–28 | 110 |
| D | 7343–31 | 150 |

*The maximum power dissipation rating must be reduced with increasing environmental operating temperatures. Refer to the Temperature Compensation Multiplier table for details.*

Using the P max of the device, the maximum allowable rms ripple current or voltage may be determined.

$I(max) = \sqrt{P\ max/R}$
$E(max) = Z\sqrt{P\ max/R}$

*I = rms ripple current (amperes)*
*E = rms ripple voltage (volts)*
*P max = maximum power dissipation (watts)*
*R = ESR at specified frequency (ohms)*
*Z = Impedance at specified frequency (ohms)*

## Reverse Voltage

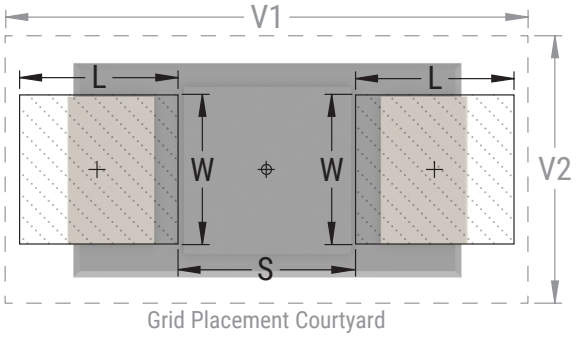
Solid tantalum capacitors are polar devices and may be permanently damaged or destroyed if connected with the wrong polarity. The positive terminal is identified on the capacitor body by a stripe, plus in some cases a beveled edge. A small degree of transient reverse voltage is permissible for short periods per the below table. The capacitors should not be operated continuously in reverse mode, even within these limits.

| Temperature | Permissible Transient Reverse Voltage |
|---|---|
| 25°C | 15% of Rated Voltage |
| 85°C | 5% of Rated Voltage |
| 125°C | 1% of Rated Voltage |

## Table 2 – Land Dimensions/Courtyard

| KEMET | Metric Size Code | Density Level A: Maximum (Most) Land Protrusion (mm) | | | | | Density Level B: Median (Nominal) Land Protrusion (mm) | | | | | Density Level C: Minimum (Least) Land Protrusion (mm) | | | | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| Case | EIA | W | L | S | V1 | V2 | W | L | S | V1 | V2 | W | L | S | V1 | V2 |
| B | 3528–21 | 2.35 | 2.21 | 0.92 | 6.32 | 4.00 | 2.23 | 1.80 | 1.12 | 5.22 | 3.50 | 2.13 | 1.42 | 1.28 | 4.36 | 3.24 |
| C | 6032-28 | 2.35 | 2.77 | 2.37 | 8.92 | 4.50 | 2.23 | 2.37 | 2.57 | 7.82 | 4.00 | 2.13 | 1.99 | 2.73 | 6.96 | 3.74 |
| D | 7343–31 | 2.55 | 2.77 | 3.67 | 10.22 | 5.60 | 2.43 | 2.37 | 3.87 | 9.12 | 5.10 | 2.33 | 1.99 | 4.03 | 8.26 | 4.84 |

***Density Level A:*** *For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes.*
***Density Level B:*** *For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes.*
***Density Level C:*** *For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC standard 7351 (IPC–7351).*
[1] *Height of these chips may create problems in wave soldering.*



Grid Placement Courtyard

## Soldering Process

The KEMET families of surface mount capacitors are compatible with wave (single or dual), convection, IR, or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/J–STD–020D standard for moisture sensitivity testing. The devices can safely withstand a maximum of three reflow passes at these conditions.

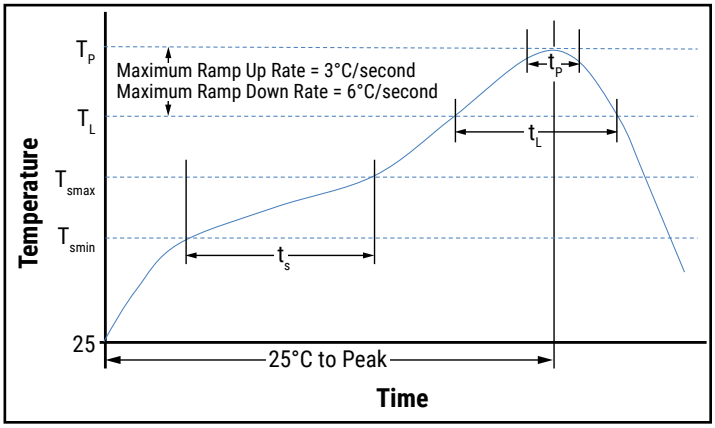
Please note that although the X/7343–43 case size can withstand wave soldering, the tall profile (4.3 mm maximum) dictates care in wave process development.

Hand soldering should be performed with care due to the difficulty in process control. If performed, care should be taken to avoid contact of the soldering iron to the molded case. The iron should be used to heat the solder pad, applying solder between the pad and the termination, until reflow occurs. Once reflow occurs, the iron should be removed immediately. “Wiping” the edges of a chip and heating the top surface is not recommended.

During typical reflow operations, a slight darkening of the gold-colored epoxy may be observed. This slight darkening is normal and not harmful to the product. Marking permanency is not affected by this change.

| Profile Feature | SnPb Assembly | Pb-Free Assembly |
|---|---|---|
| Preheat/Soak | | |
| Temperature Minimum ($T_{Smin}$) | 100°C | 150°C |
| Temperature Maximum ($T_{Smax}$) | 150°C | 200°C |
| Time ($t_s$) from $T_{smin}$ to $T_{smax}$) | 60 – 120 seconds | 60 – 120 seconds |
| Ramp-up Rate ($T_L$ to $T_P$) | 3°C/second maximum | 3°C/second maximum |
| Liquidous Temperature ($T_L$) | 183°C | 217°C |
| Time Above Liquidous ($t_L$) | 60 – 150 seconds | 60 – 150 seconds |
| Peak Temperature ($T_P$) | 220°C*<br>235°C** | 250°C*<br>260°C** |
| Time within 5°C of Maximum Peak Temperature ($t_P$) | 20 seconds maximum | 30 seconds maximum |
| Ramp-down Rate ($T_P$ to $T_L$) | 6°C/second maximum | 6°C/second maximum |
| Time 25°C to Peak Temperature | 6 minutes maximum | 8 minutes maximum |

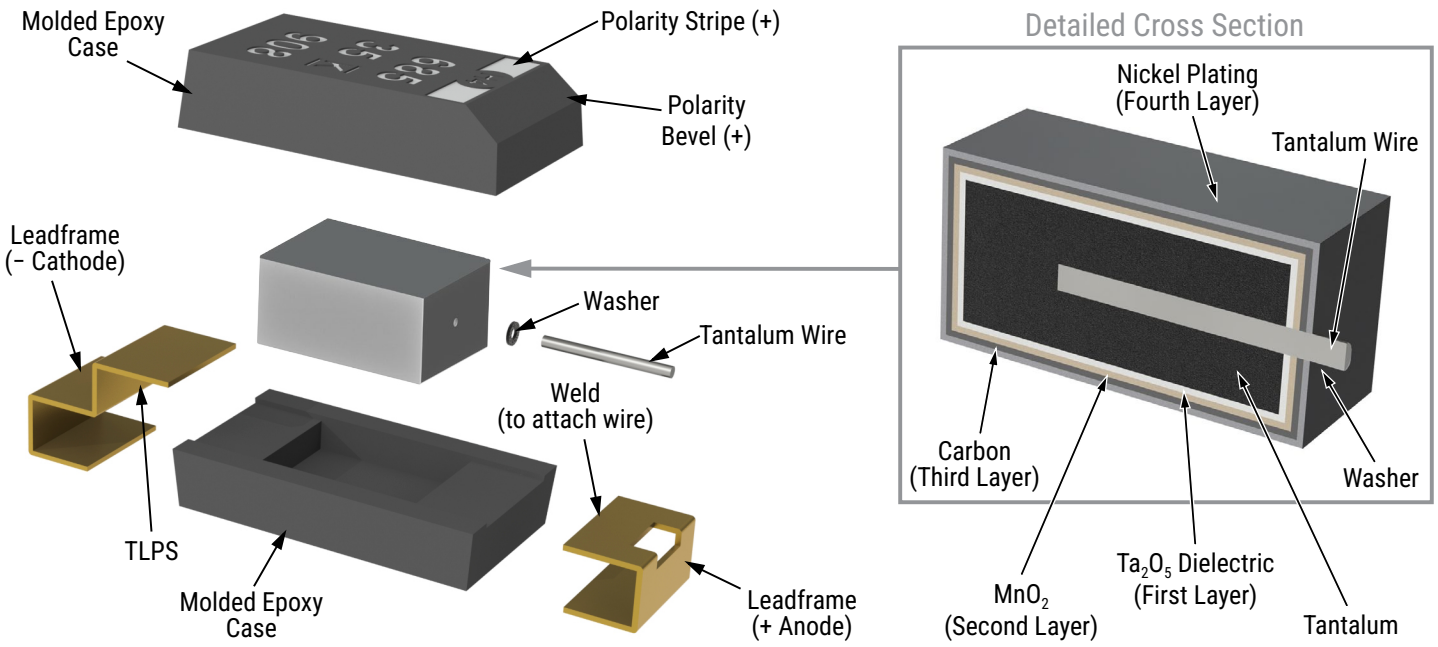
*Note: All temperatures refer to the center of the package, measured on the package body surface that is facing up during assembly reflow.*
** For Case Size height > 2.5 mm*
*** For Case Size height ≤ 2.5 mm*



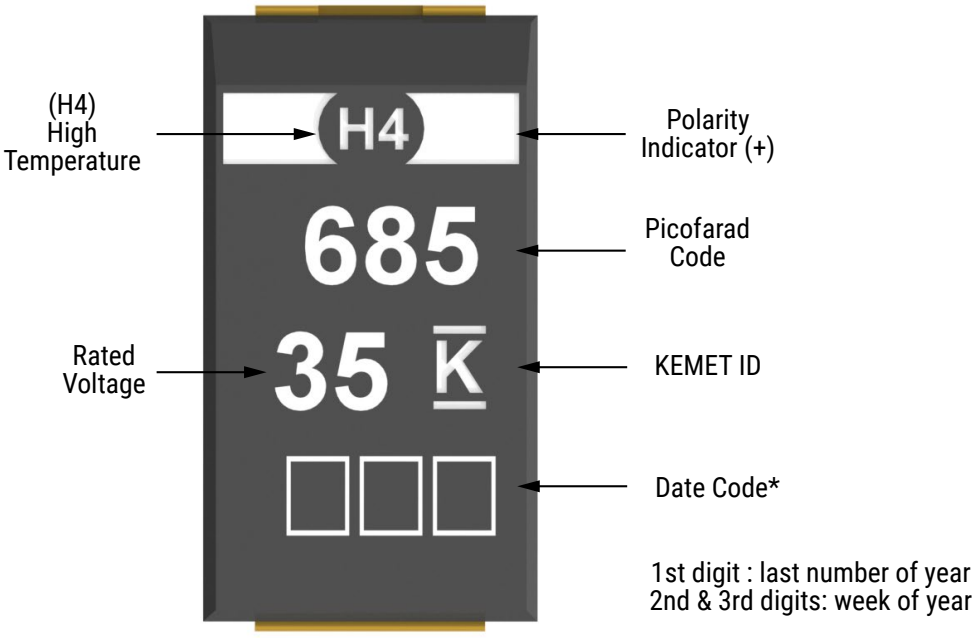

## Storage

Tantalum chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature – reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 60% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulphur bearing compounds. For optimized solderability, chip stock should be used promptly, preferably within three years of receipt.

## Construction

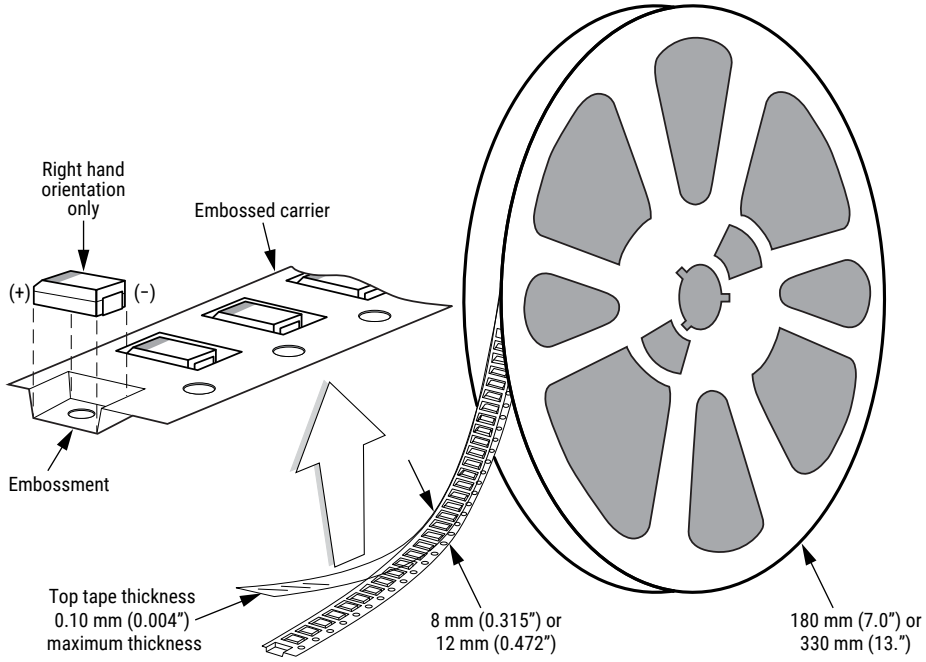



## Capacitor Marking



## Tape & Reel Packaging Information

KEMET's molded chip capacitor families are packaged in 8 and 12 mm plastic tape on 7" and 13" reels in accordance with *EIA Standard 481*: Embossed Carrier Taping of Surface Mount Components for Automatic Handling. This packaging system is compatible with all tape-fed automatic pick-and-place systems.

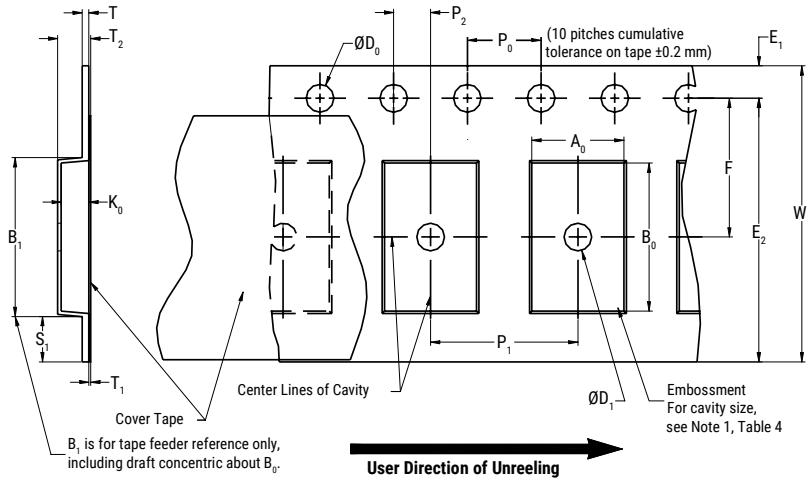



## Table 3 – Packaging Quantity

| Case Code | | Tape Width (mm) | 7" Reel* | 13" Reel* |
|---|---|---|---|---|
| KEMET | EIA | | | |
| S | 3216-12 | 8 | 2,500 | 10,000 |
| T | 3528-12 | 8 | 3,000 | 10,000 |
| M | 3528-15 | 8 | 2,500 | 8,000 |
| U | 6032-15 | 12 | 1,000 | 5,000 |
| W | 7343-15 | 12 | 1,000 | 3,000 |
| V | 7343-20 | 12 | 1,000 | 3,000 |
| A | 3216-18 | 8 | 2,000 | 9,000 |
| B | 3528-21 | 8 | 2,000 | 8,000 |
| C | 6032-28 | 12 | 500 | 3,000 |
| D | 7343-31 | 12 | 500 | 2,500 |
| X | 7343-43 | 12 | 500 | 2,000 |
| E/T428P | 7360-38 | 12 | 500 | 2,000 |

** No C-Spec required for 7" reel packaging. C-7280 required for 13" reel packaging.*

## Figure 1 – Embossed (Plastic) Carrier Tape Dimensions




## Table 4 – Embossed (Plastic) Carrier Tape Dimensions

Metric will govern

| Constant Dimensions — Millimeters (Inches) | | | | | | | | | |
|---|---|---|---|---|---|---|---|---|---|
| Tape Size | $D_0$ | $D_1$ Minimum Note 1 | $E_1$ | $P_0$ | $P_2$ | R Reference Note 2 | $S_1$ Minimum Note 3 | T Maximum | $T_1$ Maximum |
| 8 mm | 1.5 +0.10/−0.0 (0.059 +0.004/−0.0) | 1.0 (0.039) | 1.75 ±0.10 (0.069 ±0.004) | 4.0 ±0.10 (0.157 ±0.004) | 2.0 ±0.05 (0.079 ±0.002) | 25.0 (0.984) | 0.600 (0.024) | 0.600 (0.024) | 0.100 (0.004) |
| 12 mm | | 1.5 (0.059) | | | | 30 (1.181) | | | |

| Variable Dimensions — Millimeters (Inches) | | | | | | | | |
|---|---|---|---|---|---|---|---|---|
| Tape Size | Pitch | $B_1$ Maximum Note 4 | $E_2$ Minimum | F | $P_1$ | $T_2$ Maximum | W Maximum | $A_0$, $B_0$ & $K_0$ |
| 8 mm | Single (4 mm) | 4.35 (0.171) | 6.25 (0.246) | 3.5 ±0.05 (0.138 ±0.002) | 4.0 ±0.10 (0.157 ±0.004) | 2.5 (0.098) | 8.3 (0.327) | Note 5 |
| 12 mm | Single (4 mm) and Double (8 mm) | 8.2 (0.323) | 10.25 (0.404) | 5.5 ±0.05 (0.217 ±0.002) | 4.0 ±0.10 (0.157 ±0.004) or 8.0 ±0.10 (0.315 ±0.004) | 4.6 (0.181) | 12.3 (0.484) | |

*1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.*

*2. The tape, with or without components, shall pass around R without damage (see Figure 4).*

*3. If $S_1$ < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481–D, paragraph 4.3, section b).*

*4. $B_1$ dimension is a reference dimension for tape feeder clearance only.*

*5. The cavity defined by $A_0$, $B_0$ and $K_0$ shall surround the component with sufficient clearance that:*

*(a) the component does not protrude above the top surface of the carrier tape.*

*(b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.*

*(c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes (see Figure 2).*

*(d) lateral movement of the component is restricted to 0.5 mm maximum for 8 mm and 12 mm wide tape (see Figure 3).*

*(e) see Addendum in EIA Standard 481–D for standards relating to more precise taping requirements.*

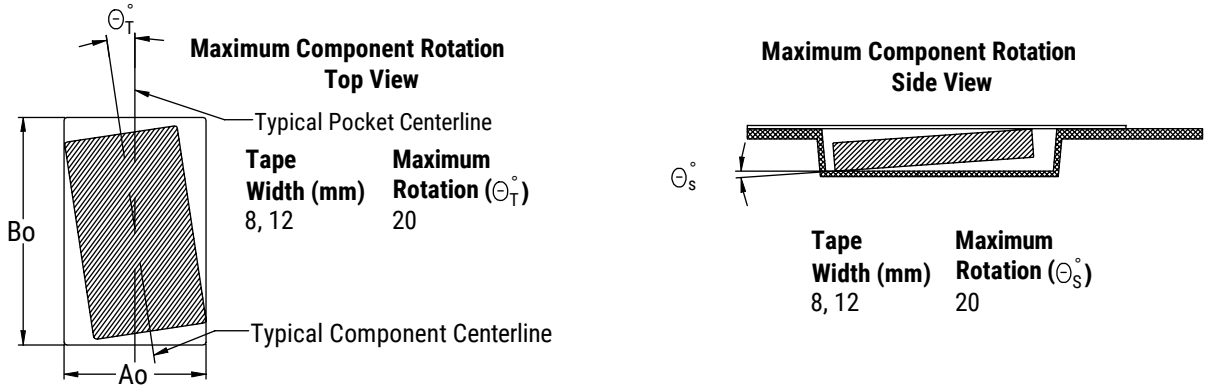
## Packaging Information Performance Notes

**1. Cover tape break force:** 1.0 kg minimum.
**2. Cover tape peel strength:** The total peel strength of the cover tape from the carrier tape shall be:

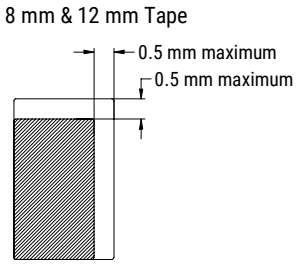
| Tape Width | Peel Strength |
|---|---|
| 8 mm | 0.1 to 1.0 newton (10 to 100 gf) |
| 12 mm | 0.1 to 1.3 newton (10 to 130 gf) |

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.
**3. Labeling:** Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. *Refer to EIA Standards 556 and 624.*

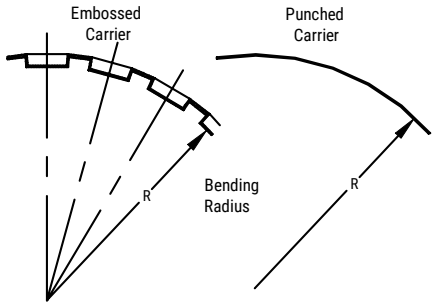
## Figure 2 – Maximum Component Rotation



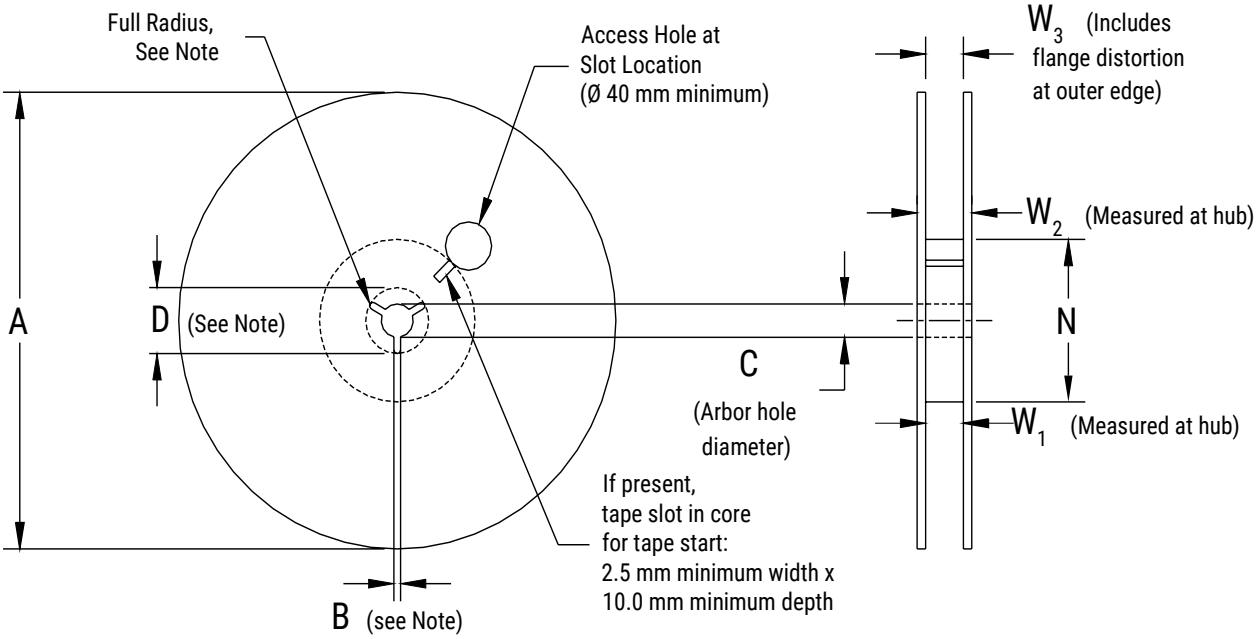

## Figure 3 – Maximum Lateral Movement




## Figure 4 – Bending Radius



## Figure 5 – Reel Dimensions




Note: Drive spokes optional; if used, dimensions B and D shall apply.

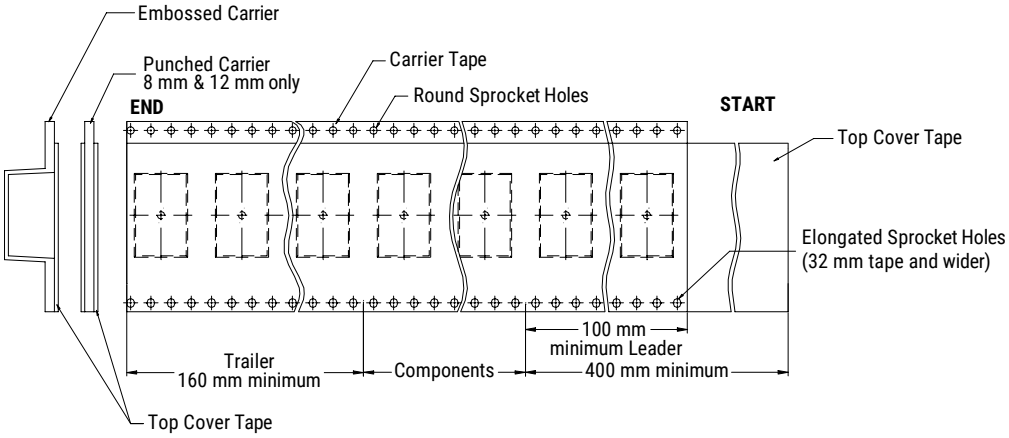
## Table 5 – Reel Dimensions

Metric will govern

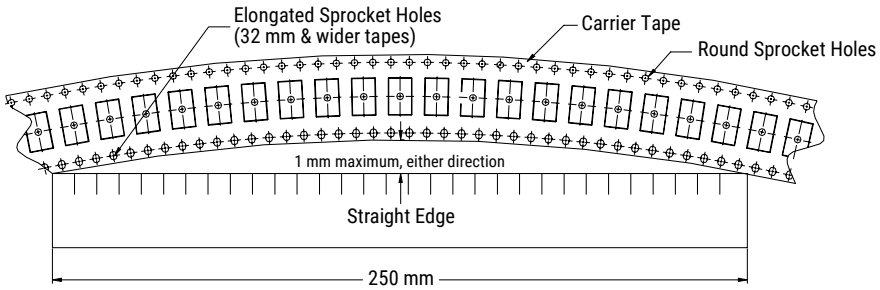
| Constant Dimensions — Millimeters (Inches) | | | | |
|---|---|---|---|---|
| Tape Size | A | B Minimum | C | D Minimum |
| 8 mm | 178 ±0.20<br>(7.008 ±0.008)<br>or<br>330 ±0.20<br>(13.000 ±0.008) | 1.5<br>(0.059) | 13.0 +0.5/–0.2<br>(0.521 +0.02/–0.008) | 20.2<br>(0.795) |
| 12 mm | | | | |

| Variable Dimensions — Millimeters (Inches) | | | | |
|---|---|---|---|---|
| Tape Size | N Minimum | $W_1$ | $W_2$ Maximum | $W_3$ |
| 8 mm | 50<br>(1.969) | 8.4 +1.5/–0.0<br>(0.331 +0.059/–0.0) | 14.4<br>(0.567) | Shall accommodate tape width without interference |
| 12 mm | | 12.4 +2.0/–0.0<br>(0.488 +0.078/–0.0) | 18.4<br>(0.724) | |

## Figure 6 – Tape Leader & Trailer Dimensions




## Figure 7 – Maximum Camber



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